

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

SAH  
#3  
1-16-01

JC474 U.S. PTO  
09/698370  
10/26/00

In re Application of:

Redline, et al.

Docket No.: 2156-056A

Serial No.:

~~To be assigned~~

Filed:

~~Concurrently herewith~~

10-26-00

Title:

Method for Enhancing Solderability of a Surface

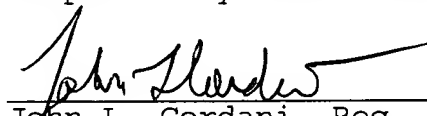
Honorable Commissioner of Patents and Trademarks  
Washington, D.C. 20231

INFORMATION DISCLOSURE STATEMENT

Pursuant to Sections 609 and 707.05(b) of the MPEP and 37 CFR 1.97-1.99, a copy is herewith submitted of documents that may be pertinent to the invention as claimed in the above-identified application. The attached form PTO-1449 (1 page) lists these documents individually.

This Information Disclosure Statement is being filed with the filing of the application and therefore, no fee is believed to be due. In the event that a fee is due, please charge Deposit Account No.: 50-0447 to cover these fees. The citation of these documents should not be construed as a representation that a thorough search has been made, or that other, more pertinent material is not available.

Respectfully submitted,



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